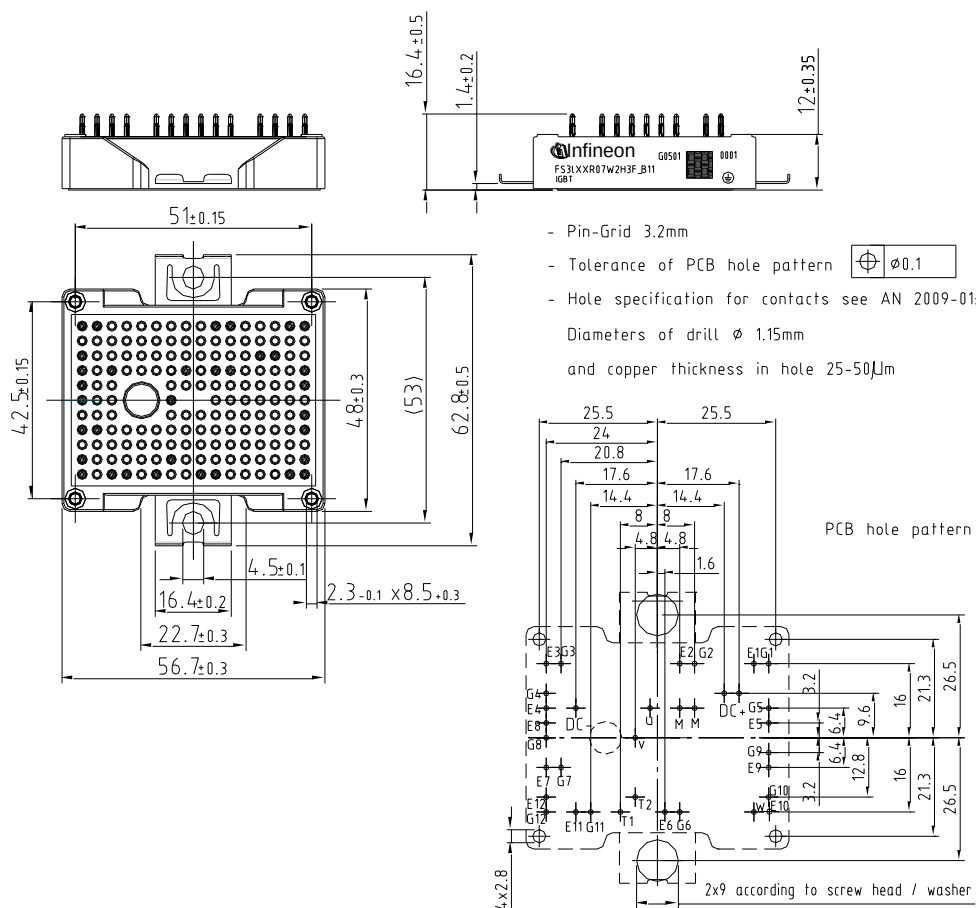
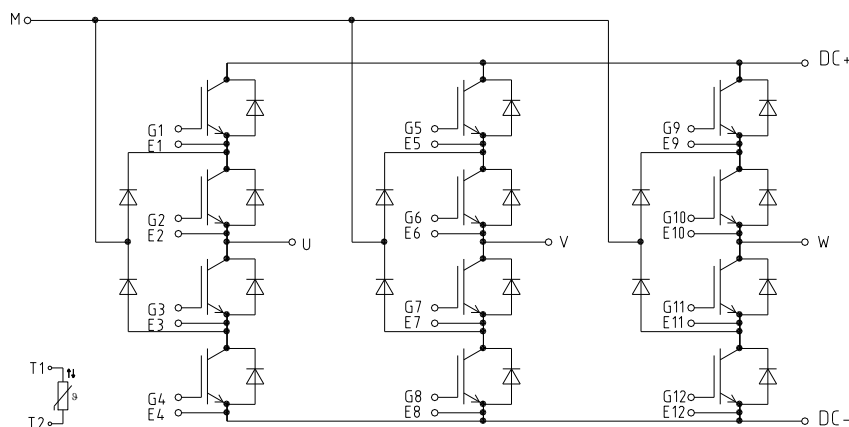


Package outline EasyPACK module AG-EASY2B-2-1



Circuit diagram FS3L50R07W2H3F_B11



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